imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconduc



FDMD8560L Dual N-Channel PowerTrench[®] MOSFET

FDMD8560L

Dual N-Channel PowerTrench[®] MOSFET Q1: 60 V, 22 A, 3.2 m Ω Q2: 60 V, 22 A, 3.2 m Ω

Features

Q1: N-Channel

- Max r_{DS(on)} = 3.2 mΩ at V_{GS} = 10 V, I_D = 22 A
- Max r_{DS(on)} = 5.4 mΩ at V_{GS} = 4.5 V, I_D = 18 A
- Q2: N-Channel
- Max r_{DS(on)} = 3.2 mΩ at V_{GS} = 10 V, I_D = 22 A
- Max $r_{DS(on)}$ = 5.4 m Ω at V_{GS} = 4.5 V, I_D = 18 A
- Ideal for Flexible Layout in Primary Side of Bridge Topology
- 100% UIL Tested
- Kelvin High Side MOSFET Drive Pin-out Capability
- RoHS Compliant



General Description

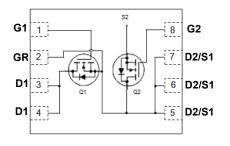
This device includes two 60V N-Channel MOSFETs in a dual power (5 mm X 6 mm) package. HS source and LS drain internally connected for half/full bridge, low source inductance package, low r_{DS(on)}/Qg FOM silicon.

Applications

G2

- Synchronous Buck: Primary Switch of Half / Full Bridge Converter for Telecom
- Motor Bridge: Primary Switch of Half / Full Bridge Converter for BLDC Motor
- MV POL: 48V Synchronous Buck Switch
- Half/Full Bridge Secondary Synchronous Rectification

Тор Bottom D2/S1 D2/S1 Pin 1 D2/S1 D1 D GF Pin 1 G1



Power 5 x 6

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter			Q1	Q2	Units
V _{DS}	Drain to Source Voltage			60	60	V
V _{GS}	Gate to Source Voltage			±20	±20	V
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	93	93	
	-Continuous	T _C = 100 °C	(Note 5)	59	59	•
D	Drain Current -Continuous	T _A = 25 °C		22 ^{1a}	22 ^{1b}	- A
	-Pulsed		(Note 4)	550	550	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	384	384	mJ
P _D	Power Dissipation	T _C = 25 °C		48	48	14/
	Power Dissipation	T _A = 25 °C		2.2 ^{1a}	2.2 ^{1b}	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to	+150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	2.6	2.6	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	55 ^{1a}	55 ^{1b}	C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMD8560L	FDMD8560L	Power 5 x 6	13 "	12 mm	3000 units

FDMD8560L I
Dual
N-Channel
PowerTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Туре	Min.	Тур.	Max.	Units
Off Cha	racteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{\rm D}$ = 250 μ A, V _{GS} = 0 V	Q1 Q2	60 60			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C	Q1 Q2		32 32		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V	Q1 Q2			1 1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V	Q1 Q2			±100 ±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, \ I_D = 250 \ \mu A$	Q1 Q2	1.0 1.0	1.6 1.6	3.0 3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C	Q1 Q2		-7 -7		mV/°C
		V _{GS} = 10 V, I _D = 22 A			2.5	3.2	mΩ
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 18\text{ A}$	Q1		4.1	5.4	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 22 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$			3.9	5.0	
20(0.1)		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 22 \text{ A}$			2.5	3.2	
		V _{GS} = 4.5 V, I _D = 18 A	Q2		4.1	5.4	-
		V_{GS} = 10 V, I_{D} = 22 A, T_{J} = 125 °C			3.9	5.0	
9 _{FS}	Forward Transconductance	V _{DD} = 5 V, I _D = 22 A	Q1 Q2		98 98		S
Dynami	c Characteristics						
C _{iss}	Input Capacitance		Q1 Q2		7420 7420	11130 11130	pF
C _{oss}	Output Capacitance	$V_{DS} = 30 V, V_{GS} = 0 V$	Q1		1110	1665	pF

Electrical Characteristics T_J = 25 °C unless otherwise noted.

Ciss	Input Capacitance		Q2		7420	11130	рі
C _{oss}	Output Capacitance	V _{DS} = 30 V, V _{GS} = 0 V f = 1 MHz	Q1 Q2		1110 1110	1665 1665	pF
C _{rss}	Reverse Transfer Capacitance		Q1 Q2		38 38	60 60	pF
R _g	Gate Resistance		Q1 Q2	0.1 0.1	1.5 1.5	3.0 3.0	Ω

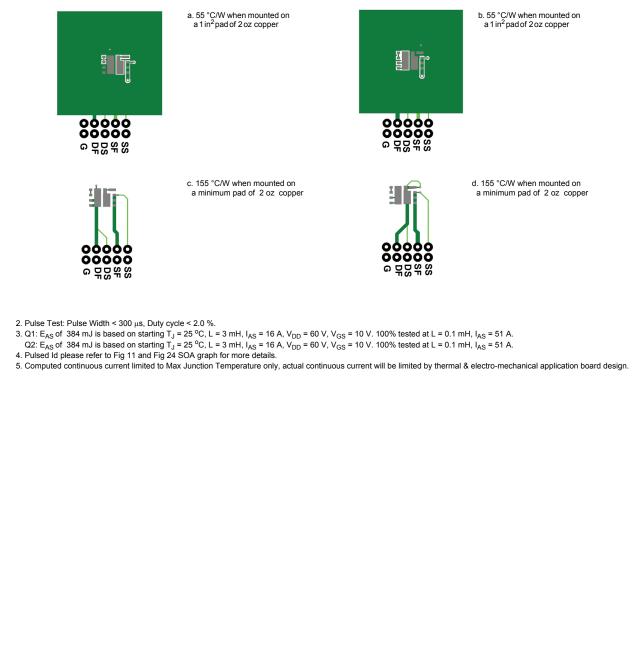
Switching Characteristics

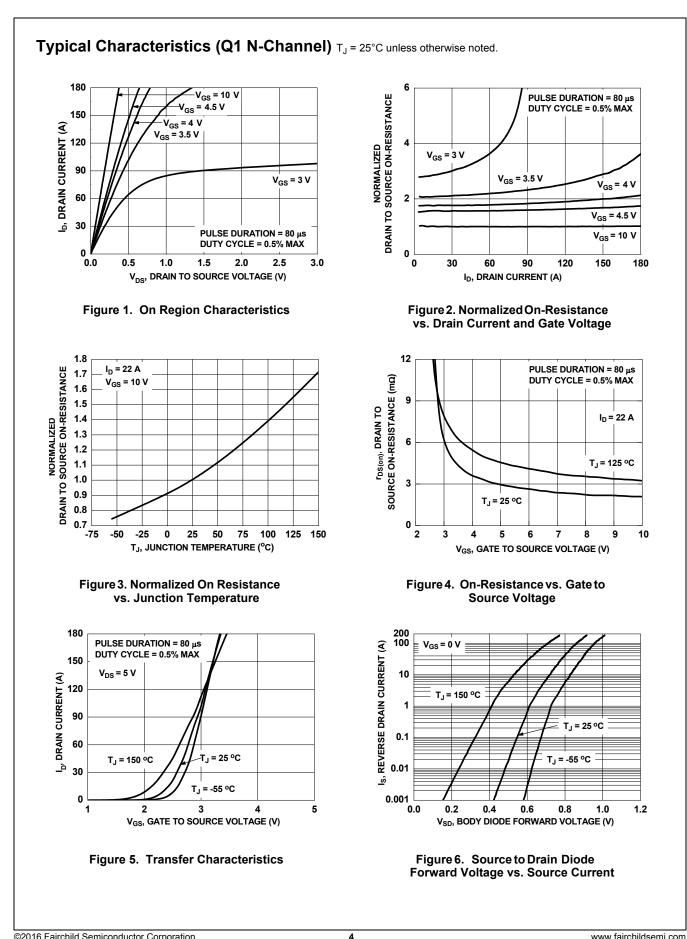
t _{d(on)}	Turn-On Delay Time			Q1 Q2	20 20	35 35	ns
t _r	Rise Time		V _{DD} = 30 V, I _D = 22 A V _{GS} = 10 V, R _{GEN} = 6 Ω	Q1	15	26	ns
•				Q2 Q1	 15 57	26 90	
t _{d(off)}	Turn-Off Delay Time	GS IC I, IGEN		Q2	57	90	ns
t _f	Fall Time			Q1 Q2	11 11	20 20	ns
Q _{g(TOT)}	Total Gate Charge	V _{GS} = 0 V to 10 V		Q1 Q2	92 92	128 128	nC
Q _{g(TOT)}	Total Gate Charge	V _{GS} = 0 V to 4.5 V	V _{DD} = 30 V,	Q2 Q1 Q2	42 42	59 59	nC
Q _{gs}	Gate to Source Charge		I _D =22 A	Q1 Q2	19 19		nC
Q _{gd}	Gate to Drain "Miller" Charge			Q1 Q2	7 7		nC

Symbol	Parameter	Test Conditions		Туре	Min.	Тур.	Max.	Units
Drain-S	ource Diode Characteristics							
V _{SD}	Source to Drain Diode Forward Voltage	$V_{22} = 0 V_{12} = 22 A_{12}$	(Note 2)	Q1		0.8	1.3	V
VSD	Source to Drain Diode i orward voltage	V _{GS} = 0 V, I _S = 22 A		Q2		0.8	1.3	
V	Source to Drain Diode Forward Voltage V_{GS} = 0 V, I_{S} = 2 A	(Note 2)	Q1		0.7	1.2	V	
V _{SD}	Source to Drain Diode I of ward voltage	$V_{GS} = 0 V, I_{S} = 2 A$		Q2		0.7	1.2	v
+	Boyoroo Boooyony Timo			Q1		53	84	20
۲r	Reverse Recovery Time			Q2		53	84	ns
O Devere Desever Charts	Boyeras Bosoyany Charge	I _F = 22 A, di/dt = 100 A/μs		Q1		44	70	20
Q _{rr}	Reverse Recovery Charge			Q2		44	70	nC

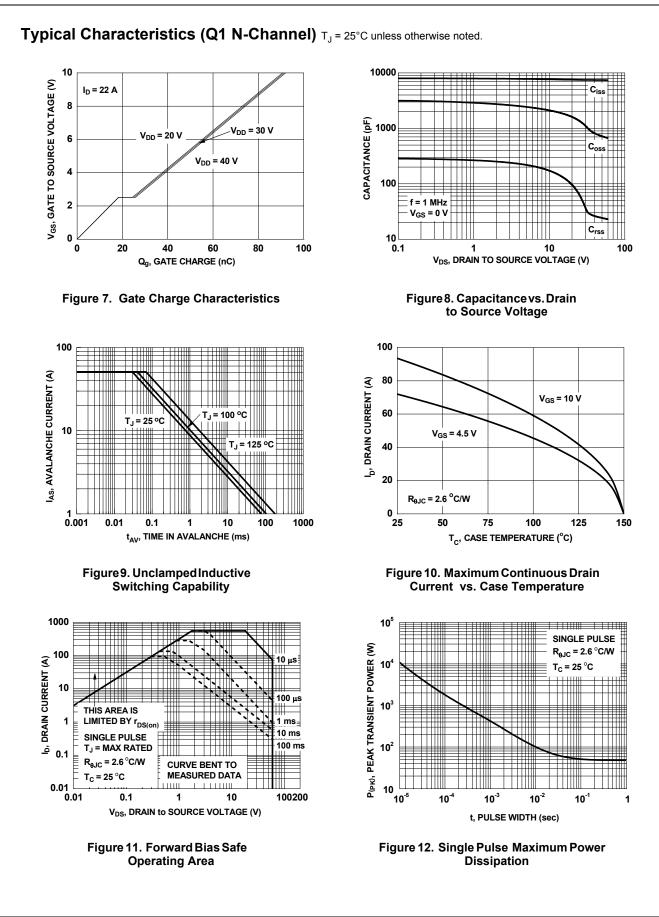
NOTES:

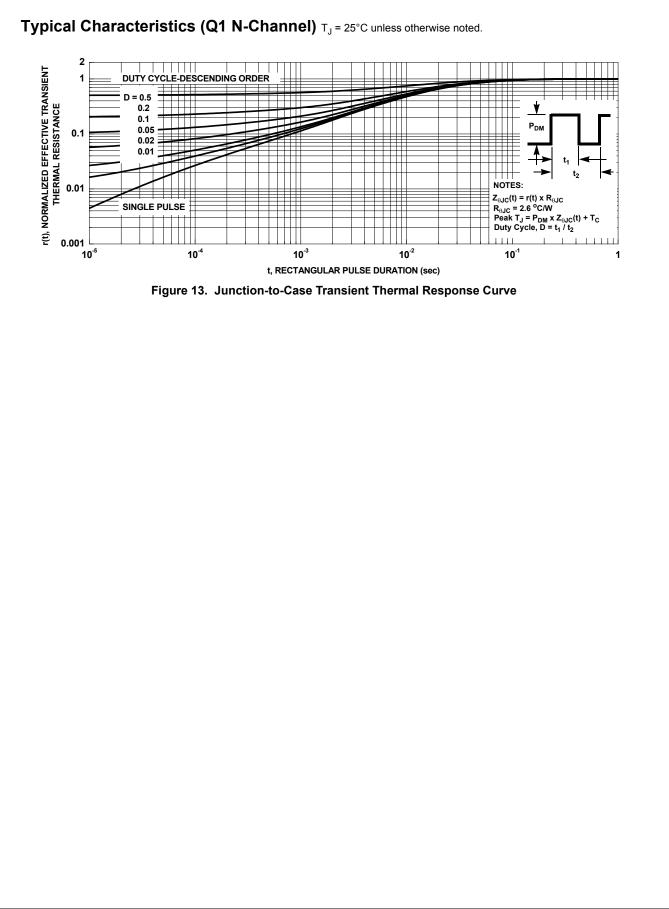
1. $R_{\theta,JC}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.

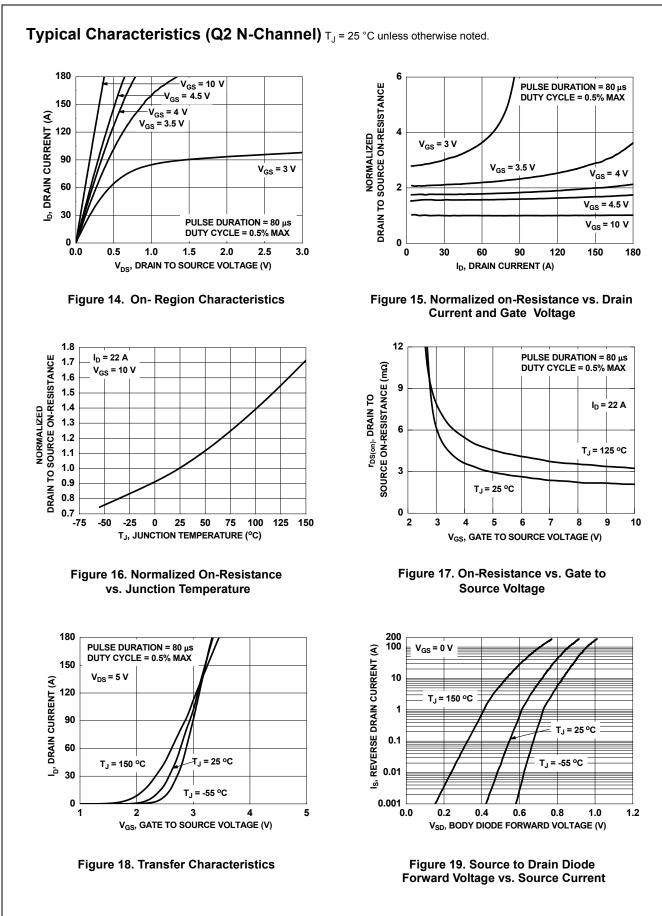




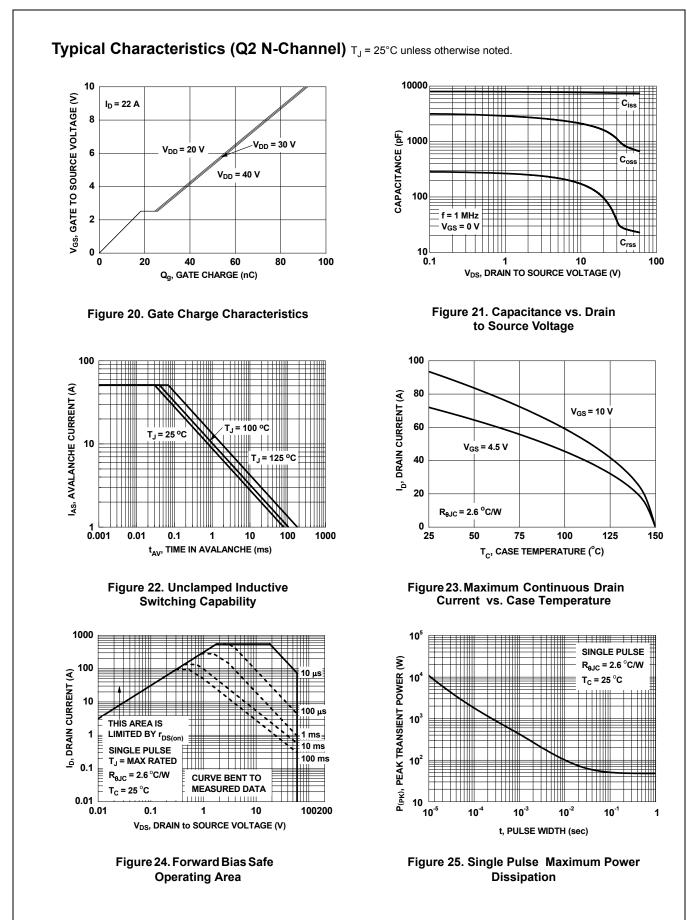


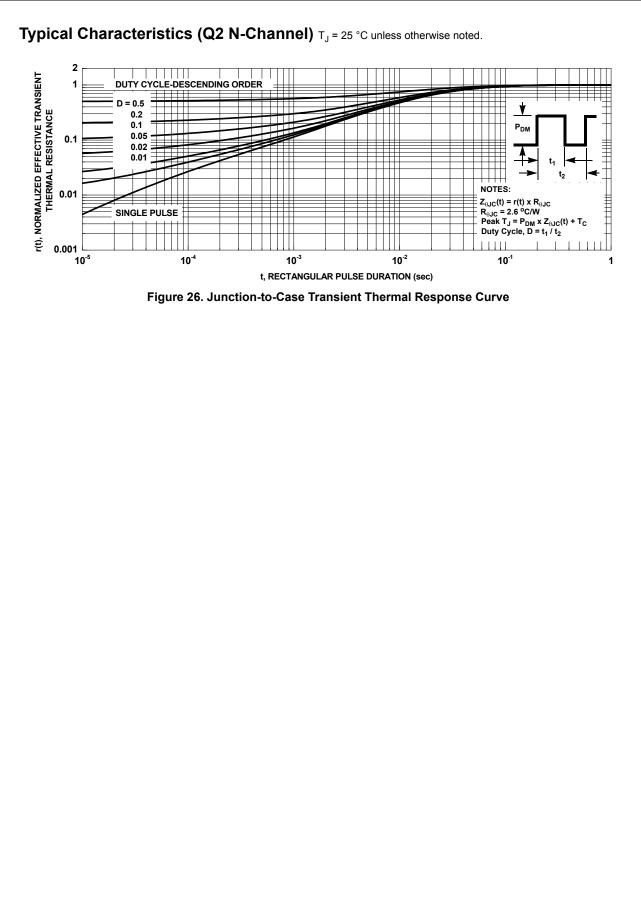


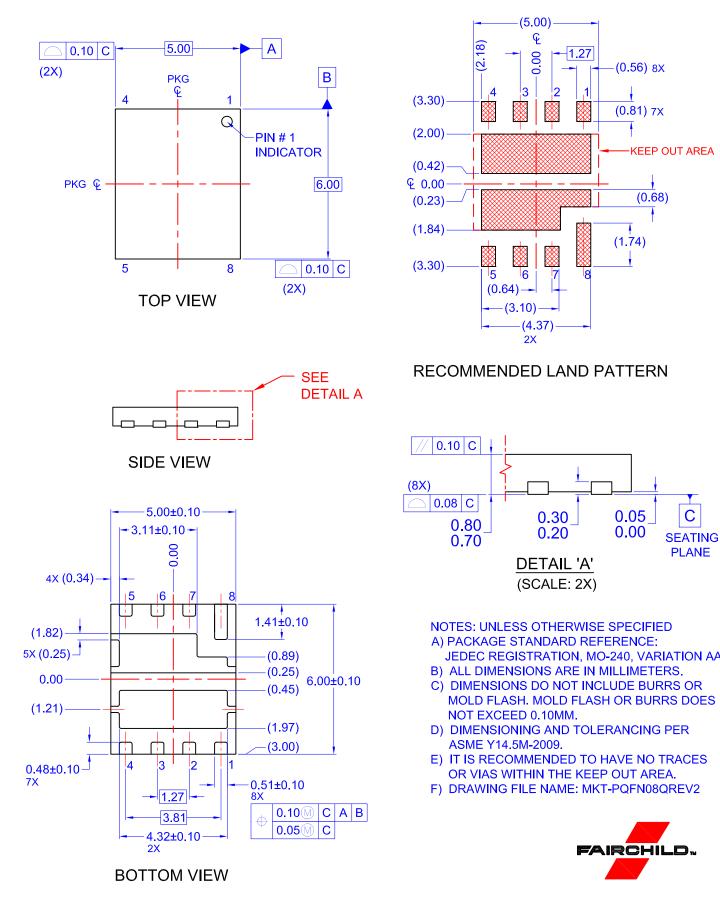












PLANE

С

- JEDEC REGISTRATION, MO-240, VARIATION AA. B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES
- D) DIMENSIONING AND TOLERANCING PER
- E) IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC